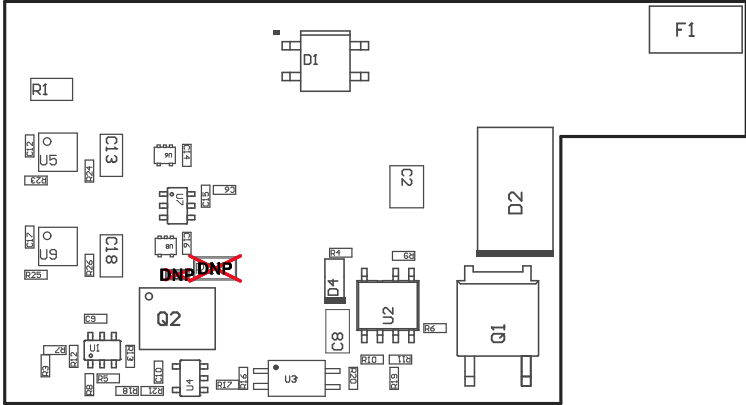


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP10885	REV: B	SUN REV: Not In VersionControl
PLOT NAME = Top Assembly Drawing	GENERATED : 3/16/2015	2:38:48 PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP10885	REV: B	SUN REV: Not In VersionControl
PLOT NAME = Bottom Assembly Drawing	GENERATED : 3/16/2015 2:38:49 PM	TEXAS INSTRUMENTS	

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